OIPE 18 7006

APR 1 8 2006

PATENT 8013-1147

## IN THE U.S. TENT AND TRADEMARK OFFICE

In re application of

Hirokazu HONDA

Conf. 7187

Application No. 09/678,609

Group 2822

Filed October 4, 2000

Examiner D. Graybill

MULTILAYER INTERCONNECTION BOARD, SEMICONDUCTOR DEVICE HAVING THE SAME, AND METHOD OF FORMING THE SAME AS WELL AS METHOD OF MOUNTING THE SEMICONDUCTOR CHIP ON THE INTERCONNECTION BOARD

## PETITION FOR EXTENSION OF TIME

Assistant Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

April 18, 2006

Sir:

The undersigned hereby petitions for an extension of time to respond to the Official Action of January 10, 2006 for one month to May 10, 2006.

Please charge the extension fee of \$120 to Deposit Account No. 25-0120. If this fee is insufficient, the Patent Office is hereby authorized to charge any additional extension fee to Deposit Account No. 25-0120. A duplicate copy of this sheet is enclosed.

A responsive paper is filed herewith.

Respectfully submitted,

YOUNG & FROMPSON

Thomas W. Perkins, Reg. No. 33,027

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